

Additional Resources: Product Page

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MODEL: CMM-3526D-261-I2S-TR | DESCRIPTION: MEMS MICROPHONE

FEATURES

- I²S technology
- digital
- omnidirectional



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ELECTRICAL

parameter	conditions/description	min	typ	max	units
directivity	omnidirectional				
sensitivity (S)	at 1 kHz, 1 Pa	-27	-26	-25	dB FS
supply voltage (Voo)		1.6	1.8	3.6	V
current consumption (loo)	at normal mode at low power mode		0.75 0.40	1.0	mA mA
clock frequency (Fclock)	at normal mode at low power mode	1.0 150	3.0	4.0 600	MHz kHz
sensitivity reduction	no change across voltage range				
frequency (f)		100		10,000	Hz
signal to noise ratio (S/N)	at 20 kHz bandwidth (A-weighted)		64		dBA
total harmonic distortion (THD)	at 94 dB SPL, 1 kHz, Rload > 2 k Ω		0.2		%
acoustic overload point (AOP)	at 94 dB SPL, 1 kHz, Rload > 2 k Ω		120		dB SPL
power supply rejection (PSR)			-72		dB FS(A)
power-up time			6	20	ms

DIGITAL INTERFACE

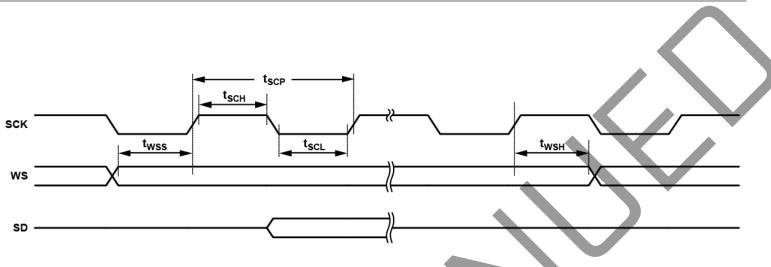
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parameter conditions/description	min typ	max	units
low voltage input (L/R, WS, SCK) (VIL)	D	0.25xVoo	V
high voltage input (L/R, WS, SCK) (VIH)	0.7xVoo	Vod	V
high voltage output (SD) (VOL)	D.1xVoo	0.3xVod	V
high voltage output (SD) (VDH)	0.7xVoo	0.9xVoo	V

I. All specifications measured at 25°C, humidity at 45±5%, L/R pins grounded, V_{DD} = 1.8 V, F_{CLOCK} = 3.072 MHz, unless otherwise noted.

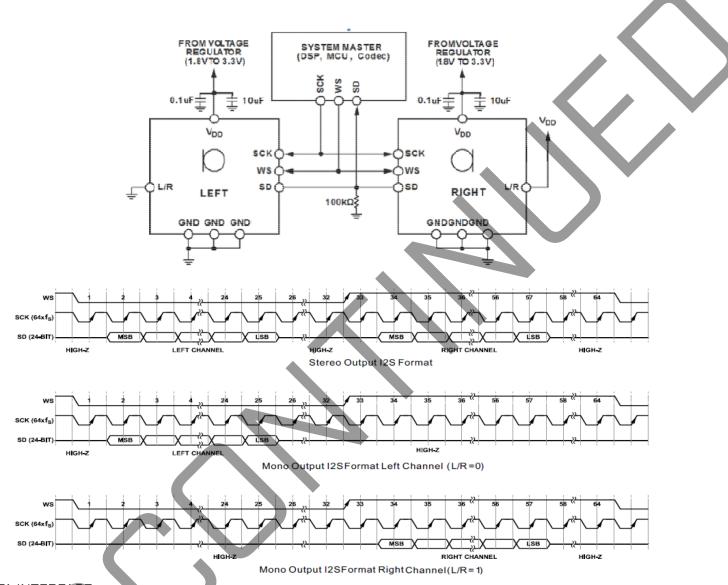
TIMING CHARACTERISTICS

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Parameter	Description	Min	Normal	Max.	Unit
t _{sch}	SCK high		50		ns
t _{scl}	SCK low		50		ns
t _{scp}	SCK period		325		ns
f _{scк}	SCK frequency		3.072		MHz
t _{wss}	WS setup		٥		ns
t _{wsH}	WS hold		20		ns
f _{ws}	WS frequency		48		kHz

RECOMMENDED INTERFACE CIRCUIT



I²S DATA INTERFACE

The serial data is in slave mode I²S format, which has 24-bit depth in a 32 bit word. In a stereoframe thereare 64 SCK cycles, or 32 SCK cycles per data-word. When L/R=0, the output data in the left channel, while L/R=Vdd, data in the right channel. The output data pin (SD) is tri-stated after the LSB is output so that another microphone can drive the common data line.

DATA WORD LENGTH

The output data-word length is 24 bits per channel. The Mic must always have 64 clock cycles for every stereo data-word $[f_{scx}=64 \times f_{ws}]$.

DATA WORD FORMAT

The default data format is I²S, MSB-first. In this format, the MSB of each word delayed by one SCK cycle from the start of each half-frame.

ENVIRONMENTAL

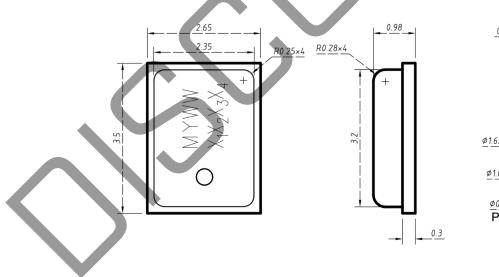
parameter	conditions/description	min	typ	max	units
operating temperature		-20		70	°C
storage temperature	in packaging	-40		100	°C
RoHS	yes				
MECHANICAL					
parameter	conditions/description	min	typ	max	units
dimensions	3.50 x 2.65 x 0.98				mm
acoustic port	bottom				
terminals	surface mount				
weight			0.03		g

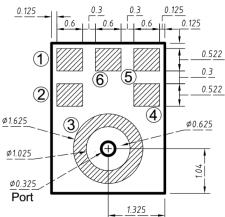
MECHANICAL DRAWING

units: mm tolerance: length, width, height: ±0.10 mm acoustic port: ±0.05 mm unless otherwise specified: ±0.15 mm

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	TERMINAL CONNECTIONS						
TERM.	SYM	FUNCTION	DESCRIPTION				
1	VDD	power	1.8 to 3.3 V. This pin should be decoupled to Pin 3 with a 0.1 μF capacitor and a 10 μF capacitor.				
2	SCK	input	Serial Data Clock for I²S Interface.				
З	GND	ground	Connect to ground on the PCB.				
4	L/R	input	eft/Right Channel Select. When set low, the microphone outputs its signal in the left hannel of the I²S frame; when set high, the microphone outputs its signal in the right.				
5	WS	input	Serial Data-Word Select for I ² S Interface.				
6	SD	output	Serial Data Output for I ² S Interface. This pin tristates when not actively driving the appropriate output channel. The SD trace should have a 100 k Ω pull-down resistor to discharge the line during the time that all microphones on the bus have tristated their outputs.				





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10K

5K

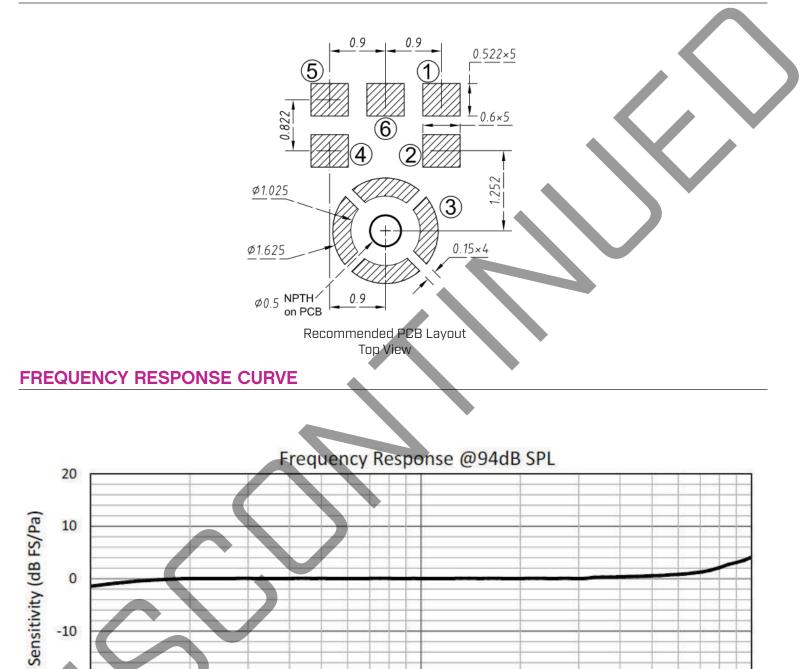
MECHANICAL DRAWING (CONTINUED)

0

-10

-20 L 100

200



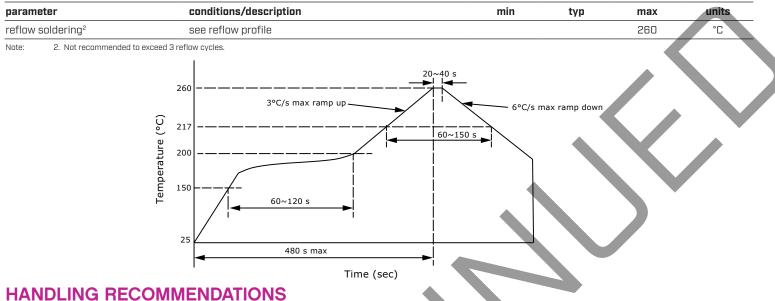
1K

Frequence (Hz)

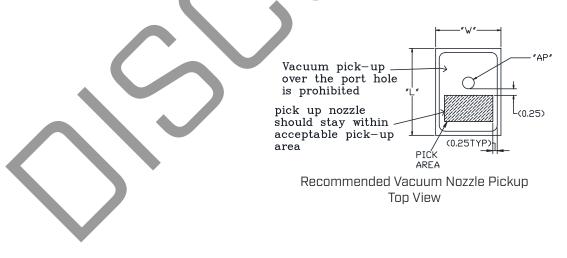
2K

500

SOLDERABILITY



- 1. Not recommended to blow air heavily over acoustic port as debris could impact mic function.
- 2. Not suitable for wash process after reflow.
- 3. Not recommended to brush board with or without solvents after reflow process.
- 4. Not recommended to directly expose to ultrasonic processing or cleaning.
- 5. Not recommended to inserty any object in port of device at any time.
- 6. Not recommended to apply over 30 psi of air pressure into the port hole.
- 7. Not recommended to pull a vacuum over port hole.
- 8. Not recommended to apply a vacuum when repackaging into sealed bag a rate faster than 0.5 atm/sec.
- 9. Not recommended to clean table or carried plate with air guarding system that could induce particle floating inside mic.



PACKAGING

	conditions/description			min	typ	max	units
ISL	Class 2a						
eel size	Ø7 inches						
eel QTY ³	1,100 pcs per reel						
arton size	310 x 210 x 165 mm						
carton QTY	5,500 pcs						
ote: 3. The leader tape of the reel,	and the beginning tape fixed into the reel ce	nter, will leave 25 bla	ank cavities each.				
				B-B A:1			
	Direction of Feed	Item	W	E	F	ØDO	КО
	Pin1 Laser mark	DIM(mm)	12.0±0.30	1.75±0.10	5.50±0.10	1.50+0.10/-0	1.25±0.10
		Item	PO	10P0	P1	AO	BO
		DIM(mm)	4.0±0.10	40.0±0.20	8.0±0.10	3.80±0.10	2.95±0.10
	Component Orientation	Item DIM(mm)	P2 2.0±0.10	T 0.25±0.05			

REVISION HISTORY

rev.	description	date	\frown
1.0	initial release	08/12/2020	
1.01	updated datasheet	11/01/2021	
1.02	logo, datasheet style update	08/05/2022	

The revision history provided is for informational purposes only and is believed to be accurate.





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